g		GE Industri	ial Systems	Functional	l Testing Spe	ecification	
	Renewal Servi Louisville,KY	ces		LOU-	-GED-3S7505P	S700	
Test Procedure for a Card							
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#### Functional test procedure for a 3S7505PS700C6

#### 1. SCOPE

1.1 This is a functional testing procedure for a. 3S7505PS700C6

## 2. STANDARDS OF QUALITY

**2.1** Refer to the current revision of the IPC-A-610 standard for workmanship standards.

## 3. APPLICABLE DOCUMENTS

3.1 The following document(s) shall form part of this specification to the extent specified herein. Unless otherwise indicated, the latest issue shall apply.
2.1.1

#### 4. ENGINEERING REQUIREMENTS

- 4.1 Equipment Cleaning
  - **4.1.1** Equipment should be clean and free of debris prior to applying power unless performing an initial check. Refer to the local documented procedures for cleaning guidelines.
- 4.2 Equipment Inspection
  - **4.2.1** Equipment should be visually inspected for any defects prior to applying power. This inspection should include the following as a minimum:
    - 4.2.1.1 Wires broken or cracked
    - 4.2.1.2 Terminal strips / connectors broken or cracked
    - **4.2.1.3** Loose wires
    - 4.2.1.4 Components visually damaged
    - 4.2.1.5 Capacitors leaking
    - 4.2.1.6 Solder joints damaged or cold
    - 4.2.1.7 Circuit board burned or de-laminated
    - 4.2.1.8 Printed wire runs burned or damaged

## 5. EQUIPMENT REQUIRED

**5.1** The following equipment is required to perform the process requirements. Equipment may be substituted provided that all accuracy's and test ratios are equivalent or better.

Qty	Reference #	Description
1		Fluke DMM or equivalent
1		Reflector

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## 6. <u>TESTING PROCESS</u>

- **6.1** Setup
  - **6.1.1** Remove back panel.
  - **6.1.2** Inside unit set relay to pick up on light.
  - **6.1.3** Attach cheater cord to terminal strip where indicated.
- **6.2** Testing Procedure
  - **6.2.1** With DMM verify N.O. contact on relay is open and N.C. contact is closed
  - **6.2.2** Apply power and verify light is coming out of glass piece on front of unit.
  - **6.2.3** Using reflector reflect light back through glass piece. Relay should energize.
  - **6.2.4** With DMM verify N.O. contact is closed and N.C. contact is open.
- 6.3 \*\*\*TEST COMPLETE \*\*\*

# 7. NOTES

If light beam to or from glass piece is broken relay will de-energize.